



📕 Order

Now







#### **INA220**

ZHCSFN7E - JUNE 2009-REVISED JANUARY 2016

# INA220 具有双线制接口的 高侧或低侧双向电流和功率监测计

#### 特性 1

- 高侧或者低侧感测
- 感测的总线电压范围: 0V 至 26V
- 报告电流、电压、和功率
- 16个可编程地址
- 高精度:整个温度范围内的精度为0.5%(最大 值)(INA220B)
- 用户可编程校准
- 快速 (2.56MHz) I<sup>2</sup>C 或 SMBUS 兼容接口
- 超薄小外形尺寸 (VSSOP)-10 封装 •

#### 应用范围 2

- 服务器
- 电信设备 .
- 笔记本电脑
- 电源管理
- 电池充电器
- 汽车
- 电源
- 测试设备

3 说明

INA220 是一款具备 I<sup>2</sup>C 或 SMBUS 兼容接口的分流器 和功率监测计。INA220 监测分流器压降和电源电压。 一个可编程校准值,与一个内部倍乘器组合在一起,可 实现电流安培值的直接读取。一个额外的乘法寄存器可 计算出功率的瓦特值。I<sup>2</sup>C 或 SMBUS 兼容接口 具有 16个可编程地址。INA220的独立分流输入允许其应 用于具备低侧感测功能的系统。

INA220 提供两种级别: A 级和 B 级。B 级型号的精度 更高且精密规范更加严格。

INA220 可在 0V 至 26V 范围内感测总线中的分压,适 用于低侧感测或 CPU 电源。该器件由 3V 至 5.5V 单 电源供电,电源的最大流耗为 1mA。INA220 的工作温 度范围为 -40°C 至 125°C。

器件信息 <sup>(1)</sup>						
器件型号	封装	封装尺寸(标称值)				
INA220	VSSOP (10)	3.00mm x 3.00mm				

(1) 要了解所有可用封装,请见数据表末尾的可订购产品附录。

## 通用负载、低侧或高侧感测





# 目录

1	特性	<u>.</u>
2	应用	范围1
3	说明	1
4	修订	历史记录 2
5	Rela	ated Products 4
6	Pin	Configuration and Functions 4
7	Spe	cifications5
	7.1	Absolute Maximum Ratings 5
	7.2	ESD Ratings5
	7.3	Recommended Operating Conditions 5
	7.4	Thermal Information 5
	7.5	Electrical Characteristics 6
	7.6	Bus Timing Diagram Definitions7
	7.7	Typical Characteristics 8
8	Deta	ailed Description 10
	8.1	Overview 10
	8.2	Functional Block Diagram 10
	8.3	Feature Description 10

# 4 修订历史记录

注: 之前版本的页码可能与当前版本有所不同。

### Changes from Revision D (September 2010) to Revision E

<ul> <li>已更改 首页图。</li></ul>	•	己添加 ESD 额定值表,特性 描述部分,器件功能模式部分,应用和实施部分,电源相关建议部分,布局部分,器件 和文档支持部分以及机械、封装和可订购信息部分	1
<ul> <li>Changed the temperature values in the Absolute Maximum Ratings table</li> <li>Changed Ambient temperature from -25 to -40 in the MIN column</li> <li>Deleted Temperature Range parameters from Electrical Characteristics</li></ul>	•	已更改 首页图。	1
<ul> <li>Changed Ambient temperature from -25 to -40 in the MIN column.</li> <li>Deleted <i>Temperature Range</i> parameters from <i>Electrical Characteristics</i>.</li> </ul>	•	Changed pin names in the pin description.	4
Deleted Temperature Range parameters from Electrical Characteristics.	•	Changed the temperature values in the Absolute Maximum Ratings table	5
	•	Changed Ambient temperature from -25 to -40 in the MIN column	5
Changed I2C timing spec change based on characterization data.	•	Deleted Temperature Range parameters from Electrical Characteristics.	7
	•	Changed I2C timing spec change based on characterization data.	7

## Changes from Revision C (September, 2009) to Revision D

•	已更改 B 级器件的高精度要点(位于特性 中)"1%"至"0.5%"	. 1
•	已添加 有关器件 A 级和 B 级型号的新段落至说明部分	. 1
•	Added new row to Packaging Information table to show new B-grade device	. 4
•	Added B-grade columns in Electrical Characteristics for MIN, TYP and MAX values	. 6
•	Changed Current Sense Gain Error over temperature specification from 10 ppm/°C to 1m%/°C	. 6
•	Added Configure/Measure/Calculate Example	25



www.ti.com.cn

	8.5	Programming 12
	8.6	Register Maps 18
9	Appl	ication and Implementation
	9.1	Application Information
	9.2	Typical Application 25
10	Pow	er Supply Recommendations 29
11	Layo	out
	11.1	Layout Guidelines 29
	11.2	Layout Example 29
12	器件	和文档支持 30
	12.1	相关文档 30
	12.2	社区资源 30
	12.3	商标
	12.4	静电放电警告 30
	12.5	Glossary 30
13	机械	、封装和可订购信息30

8.4 Device Functional Modes..... 11

# Page

Page



#### 

Texas Instruments

www.ti.com.cn

# **5** Related Products

DEVICE	DESCRIPTION	
INA209	Current/power monitor with watchdog, peak-hold, and fast comparator functions	
INA210, INA211, INA212, INA213, INA214	Zero-drift, low-cost, analog current shunt monitor series in small package	
INA219	Zero-drift, bidirectional current power monitor with two-wire interface	

# 6 Pin Configuration and Functions



#### **Pin Functions**

PIN		I/O	DESCRIPTION	
NAME	NO.	10	DESCRIPTION	
A1	1	Digital Input	Address pin. Connect to GND, SCL, SDA, or $V_S$ . Table 1 shows pin settings and corresponding addresses.	
A0	2	Digital Input	Address pin. Connect to GND, SCL, SDA, or $V_S$ . Table 1 shows pin settings and corresponding addresses.	
NC	3	_	No internal connection	
SDA	4	Digital I/O	Serial bus data line	
SCL	5	Digital Input	Serial bus clock line	
Vs	6	Analog	Power supply, 3 V to 5.5 V	
GND	7	Analog	Ground	
VBUS	8	Analog Input	Bus voltage input	
IN–	9	Analog Input	Negative differential shunt voltage. Connect to negative side of shunt resistor. Bus voltage is measured from this pin to ground.	
IN+	10	Analog Input	Positive differential shunt voltage. Connect to positive side of shunt resistor.	



## 7 Specifications

### 7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted).<sup>(1)</sup>

		MIN	MAX	UNIT
Vs	Supply voltage		6	V
Analog inputs	Differential $(V_{IN+}) - (V_{IN-})^{(2)}$	-26	26	V
IN+, IN	Common-mode (V <sub>IN+</sub> + V <sub>IN-</sub> ) / 2	-0.3	26	V
V <sub>VBUS</sub>	Voltage at VBUS pin	-0.3	26	V
V <sub>SDA</sub>	Voltage at SDA pin	GND – 0.3	6	V
V <sub>SCL</sub>	Voltage at SCL pin	GND – 0.3	V <sub>S</sub> + 0.3	V
Input current in	nto any pin		5	mA
Open-drain dig	jital output current		10	mA
Operating tem	perature	-40	125	°C
TJ	Junction temperature		150	°C
T <sub>stg</sub>	Storage temperature	-65	150	°C

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) IN+ and IN- may have a differential voltage of -26 to 26 V; however, the voltage at these pins must not exceed the range of -0.3 to 26

V.

### 7.2 ESD Ratings

			VALUE	UNIT
		Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>	±4000	
V <sub>(ESD)</sub>	Electrostatic discharge	Charged device model (CDM), per JEDEC specification JESD22-C101, all pins <sup>(2)</sup>	±1000	V
	0	Machine model (MM)	±150	

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

## 7.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	NOM	MAX	UNIT
V <sub>CM</sub>	(V <sub>IN+</sub> + V <sub>IN-</sub> ) / 2		12		V
V <sub>S</sub>	Supply voltage		3.3		V
T <sub>A</sub>	Ambient temperature	-40		85	°C

#### 7.4 Thermal Information

		INA220	
	THERMAL METRIC <sup>(1)</sup>	DGS (VSSOP)	UNIT
		10 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	165.4	°C/W
R <sub>0JC(top)</sub>	Junction-to-case (top) thermal resistance	53.2	°C/W
$R_{\thetaJB}$	Junction-to-board thermal resistance	86.6	°C/W
ΨJT	Junction-to-top characterization parameter	6.4	°C/W
Ψјв	Junction-to-board characterization parameter	85.0	°C/W

(1) For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report, SPRA953.



### 7.5 Electrical Characteristics

at  $T_A = 25^{\circ}C$ ,  $V_S = 3.3$  V,  $V_{IN+} = 12$  V,  $V_{SHUNT} = (V_{IN+} - V_{IN-}) = 32$  mV,  $V_{VBUS} = 12$  V, PGA = /1, and BRNG<sup>(1)</sup> = 1, unless otherwise noted.

			TEST CONDITIONS	11	NA220A		1	NA220B		UNIT
			TEST CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
INPUT									_	
		PGA = /1	0		±40	0		±40	mV	
Full-scale current	sense (input) voltage	M	PGA = /2	0		±80	0		±80	mV
range		V <sub>SHUNT</sub>	PGA = /4	0		±160	0		±160	mV
		PGA = /8	0		±320	0		±320	mV	
Due uskens (issue	(2)		BRNG = 1	0		32	0		32	V
Bus voltage (inpu	t voltage)		BRNG = 0	0		16	0		16	V
Common-mode rejection		V <sub>IN+</sub> = 0 to 26 V	100	120		100	120		dB	
			PGA = /1		±10	±100		±10	±50 <sup>(4)</sup>	μV
			PGA = /2		±20	±125		±20	$\pm 75^{(4)}$	μV
		Vos	PGA = /4		±30	±150		±30	±75 <sup>(4)</sup>	μV
Offset Voltage, RTI <sup>(3)</sup>			PGA = /8		±40	±200		±40	±100 <sup>(4)</sup>	μV
			$T_A = -40^{\circ}C$ to $85^{\circ}C$		0.16			0.16		μV/°C
	versus power supply	PSRR	V <sub>S</sub> = 3 to 5.5 V		10			10		μV/V
					±40			±40		m%
Current sense gain error		$T_A = -40^{\circ}C$ to $85^{\circ}C$		1			1		m%/°C	
IN+ pin input impedance		Active mode		20			20		μA	
IN- pin input impedance		Active mode		20			20		μA	
VBUS pin input in			Active mode		320			320		kΩ
IN+ pin input leak			Power-down mode		0.1	±0.5		0.1	±0.5	μA
IN- pin input leak	age <sup>(6)</sup>		Power-down mode		0.1	±0.5		0.1	±0.5	μA
DC ACCURACY										
ADC basic resolu	tion				12			12		bits
Shunt voltage			1-LSB step size		10			10		μV
Bus voltage			1-LSB step size		4			4		mV
					±0.2%	±0.5%		±0.2%	±0.3% <sup>(4)</sup>	
Current measurer	ment error		over Temperature $T_A = -40^{\circ}C$ to 85°C			±1%			±0.5% <sup>(4)</sup>	
			V <sub>BUS</sub> = 12 V		±0.2%	±0.5%		±0.2%	±0.5%	
Bus voltage meas	surement error		over Temperature $T_A = -40^{\circ}C$ to 85°C			±1%			±1%	
Differential nonlinearity				±0.1			±0.1		LSB	
ADC TIMING			1							
			12-bit		532	586		532	586	μS
			11-bit		276	304		276	304	μS
ADC conversion t	time		10-bit		148	163		148	163	μS
			9-bit		84	93		84	93	μS
Minimum convert	input low time			4			4			μS
SMBus			1							
SMBus timeout <sup>(7)</sup>	1				28	35		28	35	ms

BRNG is bit 13 of the Configuration Register 00h (see Figure 19).
 This parameter only expresses the full-scale range of the ADC scaling. In no event should more than 26 V be applied to this device.

(3) Referred-to-input (RTI)

(4) Indicates improved specifications of the INA220B.

The input impedance of this pin may vary approximately ±15%. (5)

Input leakage is positive (current flowing into the pin) for the conditions shown at the top of the table. Negative leakage currents can (6) occur under different input conditions.

SMBus timeout in the INA220 resets the interface any time SCL or SDA is low for more than 28 ms. (7)



### **Electrical Characteristics (continued)**

at  $T_A = 25^{\circ}$ C,  $V_S = 3.3$  V,  $V_{IN+} = 12$  V,  $V_{SHUNT} = (V_{IN+} - V_{IN-}) = 32$  mV,  $V_{VBUS} = 12$  V, PGA = /1, and BRNG<sup>(1)</sup> = 1, unless otherwise noted.

	TEST CONDITIONS	I	NA220A		I	NA220B		UNIT
	TEST CONDITIONS	MIN	TYP	MAX	MIN	TYP	MAX	UNIT
DIGITAL INPUTS (SDA as Input, SCL, A0, A	1)							
Input capacitance			3			3		pF
Leakage input current	$0 \le V_{IN} \le V_{S}$		0.1	1		0.1	1	μA
V <sub>IH</sub> input logic level		0.7 (V <sub>S</sub> )		6	0.7 (V <sub>S</sub> )		6	V
V <sub>IL</sub> input logic level		-0.3		0.3 (V <sub>S</sub> )	-0.3		0.3 (V <sub>S</sub> )	V
Hysteresis			500			500		mV
OPEN-DRAIN DIGITAL OUTPUTS (SDA)	· · ·							
Logic 0 output level	I <sub>SINK</sub> = 3 mA		0.15	0.4		0.15	0.4	V
High-level output leakage current	V <sub>OUT</sub> = V <sub>S</sub>		0.1	1		0.1	1	μΑ
POWER SUPPLY								
Operating supply range		3		5.5	3		5.5	V
Quiescent current			0.7	1		0.7	1	mA
Quiescent current, power-down mode			6	15		6	15	μA
Power-on reset threshold			2			2		V

# 7.6 Bus Timing Diagram Definitions<sup>(1)</sup>

		FA	ST MODE		HIGH-S	SPEED MO	DE	
		MIN	TYP	MAX	MIN	TYP	MAX	UNIT
$f_{(SCL)}$	SCL operating frequency	0.001		0.4	0.001		2.56	MHz
t <sub>(BUF)</sub>	Bus free time between STOP and START condition	1300			160			ns
t <sub>(HDSTA)</sub>	Hold time after repeated START condition After this period, the first clock is generated.	600			160			ns
t <sub>(SUSTA)</sub>	Repeated START condition setup time	600			160			ns
t <sub>(SUSTO)</sub>	STOP condition setup time	600			160			ns
t <sub>(HDDAT)</sub>	Data hold time	0		900	0		90	ns
t <sub>(SUDAT)</sub>	Data setup time	100			10			ns
t <sub>(LOW)</sub>	SCL clock LOW period	1300			250			ns
t <sub>(HIGH)</sub>	SCL clock HIGH period	600			60			ns
t <sub>F</sub> DA	Data fall time			300			150	ns
t <sub>F</sub> CL	Clock fall time			300			40	ns
t <sub>R</sub> CL	Clock rise time			300			40	ns
t <sub>R</sub> CL	Clock rise time for SCLK ≤ 100 kHz			1000				ns

(1) Values based on a statistical analysis of a one-time sample of devices. Minimum and maximum values are not ensured and not production tested. Condition: A0=A1=0.



INA220 ZHCSFN7E – JUNE 2009 – REVISED JANUARY 2016

### 7.7 Typical Characteristics

at  $T_A = 25^{\circ}$ C,  $V_S = 3.3$  V,  $V_{IN+} = 12$  V,  $V_{SHUNT} = (V_{IN+} - V_{IN-}) = 32$  mV, PGA = /1, and BRNG = 1, unless otherwise noted.





#### **Typical Characteristics (continued)**



TEXAS INSTRUMENTS

www.ti.com.cn

### 8 Detailed Description

#### 8.1 Overview

The INA220 is a digital current sense amplifier with an I<sup>2</sup>C- and SMBus-compatible interface. It provides digital current, voltage, and power readings necessary for accurate decision-making in precisely-controlled systems. Programmable registers allow flexible configuration for measurement resolution as well as continuous-versus-triggered operation. Detailed register information appears at the end of this data sheet, beginning with Table 2. See *Functional Block Diagram* for a block diagram of the INA220 device.

#### 8.2 Functional Block Diagram



#### 8.3 Feature Description

#### 8.3.1 Basic ADC Functions

The two analog inputs to the INA220, IN+ and IN–, connect to a shunt resistor in the bus of interest. Bus voltage is measured at VBUS pin. The INA220 is typically powered by a separate supply from 3 to 5.5 V. The bus being sensed can vary from 0 to 26 V. It requires no special considerations for power-supply sequencing (for example, a bus voltage can be present with the supply voltage off, and vice-versa). The INA220 senses the small drop across the shunt for shunt voltage, and senses the voltage with respect to ground from VBUS pin for the bus voltage.

When the INA220 is in the normal operating mode (that is, MODE bits of the Configuration register are set to 111), it continuously converts the shunt voltage up to the number set in the shunt voltage averaging function (Configuration register, SADC bits). The device then converts the bus voltage up to the number set in the bus voltage averaging (Configuration register, BADC bits). The Mode control in the Configuration register also permits selecting modes to convert only voltage or current, either continuously or in response to an event (triggered).

All current and power calculations are performed in the background and do not contribute to conversion time; conversion times shown in *Electrical Characteristics* can be used to determine the actual conversion time.

Power-down mode reduces the quiescent current and turns off current into the INA220 inputs, avoiding any supply drain. Full recovery from power-down requires 40  $\mu$ s. ADC off mode (set by the Configuration register, MODE bits) stops all conversions.

In triggered mode, writing any of the triggered convert modes into the Configuration register (even if the desired mode is already programmed into the register) triggers a single-shot conversion.



#### Feature Description (continued)

Although the INA220 can be read at any time, and the data from the last conversion remain available, the Conversion Ready bit (Status register, CNVR bit) is provided to help coordinate one-shot or triggered conversions. The Conversion Ready bit is set after all conversions, averaging, and multiplication operations are complete.

The Conversion Ready bit clears under any of these conditions:

- Writing to the Configuration register, except when configuring the MODE bits for power down or ADC off (disable) modes
- Reading the Status register
- Triggering a single-shot conversion with the convert pin

#### 8.3.1.1 Power Measurement

Current and bus voltage are converted at different points in time, depending on the resolution and averaging mode settings. For instance, when configured for 12-bit and 128-sample averaging, up to 68 ms in time between sampling these two values is possible. Again, these calculations are performed in the background and do not add to the overall conversion time.

#### 8.3.1.2 PGA Function

If larger full-scale shunt voltages are desired, the INA220 provides a PGA function that increases the full-scale range up to 2, 4, or 8 times (320 mV). Additionally, the bus voltage measurement has two full-scale ranges: 16 or 32 V.

#### 8.3.1.3 Compatibility With TI Hot Swap Controllers

The INA220 is designed for compatibility with hot swap controllers such the TI TPS2490. The TPS2490 uses a high-side shunt with a limit at 50 mV; the INA220 full-scale range of 40 mV enables the use of the same shunt for current sensing below this limit. When sensing is required at (or through) the 50-mV sense point of the TPS2490, the PGA of the INA220 can be set to /2 to provide an 80-mV full-scale range.

#### 8.4 Device Functional Modes

#### 8.4.1 Filtering and Input Considerations

Measuring current is often noisy, and such noise can be difficult to define. The INA220 offers several options for filtering by choosing resolution and averaging in the Configuration register. These filtering options can be set independently for either voltage or current measurement.

The internal ADC is based on a delta-sigma ( $\Delta\Sigma$ ) front-end with a 500-kHz (±30%) typical sampling rate. This architecture has good inherent noise rejection; however, transients that occur at or very close to the sampling rate harmonics can cause problems. Because these signals are at 1 MHz and higher, they can be dealt with by incorporating filtering at the input of the INA220. The high frequency enables the use of low-value series resistors on the filter for negligible effects on measurement accuracy. In general, filtering the INA220 input is only necessary if there are transients at exact harmonics of the 500-kHz (±30%) sampling rate (>1 MHz). Filter using the lowest possible series resistance and ceramic capacitor. TI recommends values of 0.1 to 1  $\mu$ F. Figure 14 shows the INA220 with an additional filter added at the input.

Overload conditions are another consideration for the INA220 inputs. The INA220 inputs are specified to tolerate 26 V across the inputs. A large differential scenario might be a short to ground on the load side of the shunt. This type of event can result in full power-supply voltage across the shunt (as long the power supply or energy storage capacitors support it). It must be remembered that removing a short to ground can result in inductive kickbacks that could exceed the 26-V differential and common-mode rating of the INA220. Inductive kickback voltages are best dealt with by Zener-type transient-absorbing devices combined with sufficient energy storage capacitance.



#### **Device Functional Modes (continued)**

In applications that do not have large energy storage electrolytics on one or both sides of the shunt, an input overstress condition may result from an excessive dV/dt of the voltage applied to the input. A hard physical short is the most likely cause of this event, particularly in applications with no large electrolytics present. This problem occurs because an excessive dV/dt can activate the ESD protection in the INA220 in systems where large currents are available. Testing has demonstrated that the addition of  $10-\Omega$  resistors in series with each input of the INA220 sufficiently protects the inputs against dV/dt failure up to the 26-V rating of the INA220. These resistors have no significant effect on accuracy.



Figure 14. INA220 With Input Filtering

#### 8.5 Programming

#### 8.5.1 Programming the INA220 Calibration Register

*Register Details* shows the default power-up states of the registers. These registers are volatile, and if programmed to anything other than default values, they must be reprogrammed at every device power-up. The Calibration Register is calculated based on Equation 1. This equation includes the term Current\_LSB, which is the programmed value for the LSB for the Current Register (04h). The Current\_LSB value is used to convert the value in the Current Register (04h) to the actual current in amperes. The highest resolution for the Current Register (04h) can be obtained by using the smallest allowable Current\_LSB based on the maximum expected current as shown in Equation 2. While this value yields the highest resolution, it is common to select a value for the Current\_LSB to the nearest round number above this value to simplify the conversion of the Current Register (04h) and Power Register (03h) to amperes and watts respectively. The R<sub>SHUNT</sub> term is the value of the external shunt used to develop the differential voltage across the input pins. The Power Register (03h) is internally set to be 20 times the programmed Current\_LSB (see Equation 3).

$$Cal = trunc \left( \frac{0.04096}{Current\_LSB \times R_{SHUNT}} \right)$$

where

• 0.04096 is an internal fixed value used to ensure scaling is maintained properly

<ul> <li>Current_LSB is the programmed value for the LSB for the Current Register (04h)</li> </ul>	(1)
Current LSB = $\frac{\text{Maximum Expected Current}}{4\pi}$	
2 <sup>15</sup>	(2)

Power\_LSB = 20 Current\_LSB

(3)



#### **Programming (continued)**

Shunt voltage is calculated by multiplying the Shunt Voltage Register contents with the Shunt Voltage LSB of 10  $\mu$ V. The Bus Voltage register bits are not right-aligned. To compute the value of the Bus Voltage, Bus Voltage Register contents must be shifted right by three bits. This shift puts the BD0 bit in the LSB position so that the contents can be multiplied by the Bus Voltage LSB of 4-mV to compute the bus voltage measured by the device. After programming the Calibration Register, the value expected in the Current Register (04h) can be calculated by multiplying the Shunt Voltage register contents by the Calibration Register and then dividing by 4096 as shown in Equation 4. To obtain a value in amperes, the Current register value is multiplied by the programmed Current\_LSB.

$$Current Register = \frac{Shunt Voltage Register \times Calibration Register}{4096}$$
(4)

The value expected in the Power register (03h) can be calculated by multiplying the Current register value by the Bus Voltage register value and then dividing by 5000 as shown in Equation 5. Power Register content is multiplied by Power LSB which is 20 times the Current\_LSB for a power value in watts.

Power Register = 
$$\frac{\text{Current Register} \times \text{Bus Voltage Register}}{5000}$$

#### 8.5.2 Programming the INA220 Power Measurement Engine

#### 8.5.2.1 Calibration Register and Scaling

The Calibration register makes it possible to set the scaling of the Current and Power registers to whatever values are most useful for a given application. One strategy may be to set the Calibration register such that the largest possible number is generated in the Current register or Power register at the expected full-scale point; this approach yields the highest resolution. The Calibration register can also be selected to provide values in the Current and Power registers that either provide direct decimal equivalents of the values being measured, or yield a round LSB number. After these choices have been made, the Calibration register also offers possibilities for end-user system-level calibration, where the value is adjusted slightly to cancel total system error. After determining the exact current by using an external ammeter, the value of the Calibration Register can then be adjusted based on the measured current result of the INA220 to cancel the total system error as shown in Equation 6.

$$Corrected\_Full\_Scale\_Cal = trunc \left( \frac{Cal \times MeasShuntCurrent}{INA220\_Current} \right)$$
(6)

#### 8.5.3 Simple Current Shunt Monitor Usage (No Programming Necessary)

The INA220 can be used without any programming if it is only necessary to read a shunt voltage drop and bus voltage with the default 12-bit resolution, 320-mV shunt full-scale range (PGA = /8), 32-V bus full-scale range, and continuous conversion of shunt and bus voltage.

Without programming, current is measured by reading the shunt voltage. The Current register and Power register are only available if the Calibration register contains a programmed value.

#### 8.5.4 Bus Overview

The INA220 offers compatibility with both I<sup>2</sup>C and SMBus interfaces. The I<sup>2</sup>C and SMBus protocols are essentially compatible with one another.

The I<sup>2</sup>C interface is used throughout this data sheet as the primary example, with SMBus protocol specified only when a difference between the two systems is being addressed. Two lines, SCL and SDA, connect the INA220 to the bus. Both SCL and SDA are open-drain connections.

The device that initiates the transfer is called a *master*, and the devices controlled by the master are *slaves*. The bus must be controlled by a master device that generates the serial clock (SCL), controls the bus access, and generates START and STOP conditions.

(5)



#### **Programming (continued)**

To address a specific device, the master initiates a START condition by pulling the data signal line (SDA) from a high to a low logic level while SCL is high. All slaves on the bus shift in the slave address byte on the rising edge of SCL, with the last bit indicating whether a read or write operation is intended. During the ninth clock pulse, the slave being addressed responds to the master by generating an Acknowledge and pulling SDA low.

Data transfer is then initiated and eight bits of data are sent, followed by an *Acknowledge* bit. During data transfer, SDA must remain stable while SCL is high. Any change in SDA while SCL is high is interpreted as a START or STOP condition.

After all data have been transferred, the master generates a STOP condition, indicated by pulling SDA from low to high while SCL is high. The INA220 includes a 28-ms timeout on its interface to prevent locking up an SMBus.

#### 8.5.4.1 Serial Bus Address

To communicate with the INA220, the master must first address slave devices through a slave address byte. The slave address byte consists of seven address bits, and a direction bit indicating the intent of executing a read or write operation.

The INA220 has two address pins, A0 and A1. Table 1 describes the pin logic levels for each of the 16 possible addresses. The state of pins A0 and A1 is sampled on every bus communication and should be set before any activity on the interface occurs. The address pins are read at the start of each communication event.

A1	A0	SLAVE ADDRESS
GND	GND	1000000
GND	Vs	1000001
GND	SDA	1000010
GND	SCL	1000011
Vs	GND	1000100
Vs	Vs	1000101
Vs	SDA	1000110
Vs	SCL	1000111
SDA	GND	1001000
SDA	Vs	1001001
SDA	SDA	1001010
SDA	SCL	1001011
SCL	GND	1001100
SCL	Vs	1001101
SCL	SDA	1001110
SCL	SCL	1001111

#### Table 1. INA220 Address Pins and Slave Addresses

#### 8.5.4.2 Serial Interface

The INA220 operates only as a slave device on the I<sup>2</sup>C bus and SMBus. Connections to the bus are made by the open-drain I/O lines SDA and SCL. The SDA and SCL pins feature integrated spike suppression filters and Schmitt triggers to minimize the effects of input spikes and bus noise. The INA220 supports the transmission protocol for fast (1-kHz to 400-kHz) and high-speed (1-kHz to 2.56-MHz) modes. All data bytes are transmitted most significant byte first.

#### 8.5.5 Writing to and Reading from the INA220

Accessing a particular register on the INA220 is accomplished by writing the appropriate value to the register pointer. Refer to Table 2 for a complete list of registers and corresponding addresses. The value for the register pointer, as shown in Figure 18, is the first byte transferred after the slave address byte with the R/W bit LOW. Every write operation to the INA220 requires a value for the register pointer.



Writing to a register begins with the first byte transmitted by the master. This byte is the slave address, with the R/W bit LOW. The INA220 then acknowledges receipt of a valid address. The next byte transmitted by the master is the address of the register to which data will be written. This register address value updates the register pointer to the desired register. The next two bytes are written to the register addressed by the register pointer. The INA220 acknowledges receipt of each data byte. The master may terminate data transfer by generating a START or STOP condition.

When reading from the INA220, the last value stored in the register pointer by a write operation determines which register is read during a read operation. To change the register pointer for a read operation, a new value must be written to the register pointer. This write is accomplished by issuing a slave address byte with the R/W bit LOW, followed by the register pointer byte. No additional data are required. The master then generates a START condition and sends the slave address byte with the R/W bit HIGH to initiate the read command. The next byte is transmitted by the slave and is the most significant byte of the register indicated by the register pointer. This byte is followed by an *Acknowledge* from the master; then the slave transmits the least significant byte. The master acknowledges receipt of the data byte. The master may terminate data transfer by generating a *Not Acknowledge* after receiving any data byte, or generating a START or STOP condition. If repeated reads from the same register are desired, it is not necessary to continually send the register pointer bytes; the INA220 retains the register pointer value until it is changed by the next write operation.

Figure 15 and Figure 16 show write and read operation timing diagrams, respectively. Note that register bytes are sent most-significant byte first, followed by the least significant byte. Figure 17 shows the timing diagram for the SMBus Alert response operation. Figure 18 shows a typical register pointer configuration.







NOTE (1): The value of the Slave Address Byte is determined by the settings of the A0 and A1 pins. Refer to Table 1.





NOTES: (1) The value of the Slave Address Byte is determined by the settings of the A0 and A1 pins. Refer to Table 1.

(2) Read data is from the last register pointer location. If a new register is desired, the register

pointer must be updated. See Figure 19.

(3) ACK by Master can also be sent.

Figure 16. Timing Diagram for Read Word Format





NOTE (1): The value of the Slave Address Byte is determined by the settings of the A0 and A1 pins. Refer to Table 1.





NOTE (1): The value of the Slave Address Byte is determined by the settings of the A0 and A1 pins. Refer to Table 1.

Figure 18. Typical Register Pointer Set

INA220 ZHCSFN7E – JUNE 2009–REVISED JANUARY 2016



#### 8.5.5.1 High-Speed Two-Wire Mode

When the bus is idle, both the SDA and SCL lines are pulled high by the pullup devices. The master generates a start condition followed by a valid serial byte containing high-speed (HS) master code *00001XXX*. This transmission is made in fast (400 kbps) or standard (100 kbps) (F/S) mode at no more than 400 kbps. The INA220 does not acknowledge the HS master code, but does recognize it and switches its internal filters to support 2.56-Mbps operation.

The master then generates a repeated start condition (a repeated start condition has the same timing as the start condition). After this repeated start condition, the protocol is the same as F/S mode, except that transmission speeds up to 2.56 Mbps are allowed. Instead of using a stop condition, repeated start conditions should be used to secure the bus in HS-mode. A STOP condition ends the HS-mode and switches all the internal filters of the INA220 to support the F/S mode. See *Bus Timing Diagram Definitions*<sup>(1)</sup> and Figure 1 for timing.

#### 8.5.5.2 Power-Up Conditions

Power-up conditions apply to a software reset through the RST bit (bit 15) in the Configuration register, or the I<sup>2</sup>C bus General Call Reset.

#### 8.6 Register Maps

#### 8.6.1 Register Information

The INA220 uses a bank of registers for holding configuration settings, measurement results, and status information. Table 2 summarizes the INA220 registers; *Functional Block Diagram* illustrates the registers.

Register contents are updated 4  $\mu$ s after completion of the write command. Therefore, a 4- $\mu$ s delay is required between completion of a write to a given register and a subsequent read of that register (without changing the pointer) when using SCL frequencies in excess of 1 MHz.

POINTER ADDRESS	REGISTER NAME FUNCTION		POWER-ON RES	BET .	TYPE <sup>(1)</sup>
HEX			BINARY	HEX	
00	Configuration	All-register reset, settings for bus voltage range, PGA gain, ADC resolution/averaging.	00111001 10011111	399F	R/W
01	Shunt voltage	Shunt voltage measurement data.	Shunt voltage	—	R
02	Bus voltage	Bus voltage measurement data.	Bus voltage	_	R
03	Power <sup>(2)</sup>	Power measurement data.	0000000 0000000	0000	R
04	Current <sup>(2)</sup>	Contains the value of the current flowing through the shunt resistor.	0000000 0000000	0000	R
05	Calibration	Sets full-scale range and LSB of current and power measurements. Overall system calibration.	0000000 0000000	0000	R/W

Table 2. Summary of Register Set

(1) Values based on a statistical analysis of a one-time sample of devices. Minimum and maximum values are not ensured and not production tested. Condition: A0=A1=0.

(1) Type:  $\mathbf{R}$  = Read only,  $\mathbf{R}/\overline{\mathbf{W}}$  = Read/Write.

(2) The Power register and Current register default to 0 because the Calibration register defaults to 0, yielding a zero current value until the Calibration register is programmed.



#### 8.6.2 Register Details

All INA220 registers 16-bit registers are actually two 8-bit bytes through the I<sup>2</sup>C- or SMBUS-compatible interface.

#### 8.6.2.1 Configuration Register (address = 00h) [reset = 399Fh]

#### Figure 19. Configuration Register

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RST	_	BRNG	PG1	PG0	BADC 4	BADC 3	BADC 2	BADC 1	SADC 4	SADC 3	SADC 2	SADC 1	MODE 3	MODE 2	MODE 1
R/W- 0	R/W- 0	R/W-1	R/W-1	R/W-1	R/W-0	R/W-0	R/W-1	R/W-1	R/W-0	R/W-0	R/W-1	R/W-1	R/W-1	R/W-1	R/W-1

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

# RST: Reset Bit Bit 15 Setting this bit to 1 generates a system reset that is the same as power-on reset. Resets all registers to default values; this bit self-clears.

BRNG: Bus Voltage Range

Bit 13 0 = 16-V FSR

1 = 32-V FSR (default value)

#### PG: PGA (Shunt Voltage Only)

Bits 11, 12 Sets PGA gain and range. Note that the PGA defaults to ÷8 (320-mV range). Table 3 shows the gain and range for the various product gain settings.

#### Table 3. PG Bit Settings [12:11] <sup>(1)</sup>

PG1	PG0	GAIN	RANGE
0	0	1	±40 mV
0	1	/2	±80 mV
1	0	/4	±160 mV
1	1	/8	±320 mV

(1) Shaded values are default.

#### BADC: BADC Bus ADC Resolution/Averaging

Bits 7–10 These bits adjust the Bus ADC resolution (9-, 10-, 11-, or 12-bit) or set the number of samples used when averaging results for the Bus Voltage Register (02h).

#### SADC: SADC Shunt ADC Resolution/Averaging

 Bits 3–6
 These bits adjust the Shunt ADC resolution (9-, 10-, 11-, or 12-bit) or set the number of samples used when averaging results for the Shunt Voltage Register (01h).

 BADC (Bus) and SADC (Shunt) ADC resolution/averaging and conversion time settings are shown in Table 4.

### Table 4. ADC Settings (SADC [6:3], BADC [10:7])<sup>(1)</sup>

ADC4	ADC3	ADC2	ADC1	Mode/Samples	Conversion Time
0	X <sup>(2)</sup>	0	0	9-bit	84 μs
0	X <sup>(2)</sup>	0	1	10-bit	148 μs
0	X <sup>(2)</sup>	1	0 11-bit		<b>276</b> μs
0	X <sup>(2)</sup>	1	1	12-bit	532 μs
1	0	0	0	12-bit	532 μs
1	0	0	1	2	1.06 ms
1	0	1	0	4	2.13 ms
1	0	1	1	8	4.26 ms
1	1	0	0	16	8.51 ms
1	1	0	1	32	17.02 ms

(1) Shaded values are default.

(2) X = Don't care

Table 4. ADC Settings (SADC [0.3], DADC [10.7])* (Continueu)	Table 4. ADC Settings	(SADC [6	:3], BADC [	10:7]) <sup>()</sup> (	(continued)
--	-----------------------	----------	-------------	------------------------	-------------

ADC4	ADC3	ADC2	ADC1	Mode/Samples	Conversion Time
1	1	1	0	64	34.05 ms
1	1	1	1	128	68.10 ms

#### MODE: Operating Mode

Bits 0–2

Selects continuous, triggered, or power-down mode of operation. These bits default to continuous shunt and bus measurement mode. The mode settings are shown in Table 5.

MODE3	MODE2	MODE1	MODE										
0	0	0	Power-down										
0	0	1	Shunt voltage, triggered										
0	1	0	Bus voltage, triggered										
0	1	1	Shunt and bus, triggered										
1	0	0	ADC off (disabled)										
1	0	1	Shunt voltage, continuous										
1	1	0	Bus voltage, continuous										
1	1	1	Shunt and bus, continuous										

#### Table 5. Mode Settings [2:0]<sup>(1)</sup>

(1) Shaded values are default.

#### 8.6.3 Data Output Registers

#### 8.6.3.1 Shunt Voltage Register (address = 01h)

The Shunt Voltage register stores the current shunt voltage reading,  $V_{SHUNT}$ . Shunt Voltage register bits are shifted according to the PGA setting selected in the Configuration register (00h). When multiple sign bits are present, they are all the same value. Negative numbers are represented in 2's complement format. Generate the 2's complement of a negative number by complementing the absolute value binary number and adding 1. Extend the sign, denoting a negative number by setting the MSB = 1. Extend the sign to any additional sign bits to form the 16-bit word.

Example: For a value of  $V_{SHUNT} = -320 \text{ mV}$ :

- 1. Take the absolute value (include accuracy to 0.01 mV)  $\rightarrow$  320.00
- 2. Translate this number to a whole decimal number  $\rightarrow$  32000
- 3. Convert it to binary  $\rightarrow$  111 1101 0000 0000
- 4. Complement the binary result : 000 0010 1111 1111
- 5. Add 1 to the complement to create the 2's-complement formatted result  $\rightarrow$  000 0011 0000 0000
- 6. Extend the sign and create the 16-bit word: 1000 0011 0000 0000 = 8300h (Remember to extend the sign to all sign-bits, as necessary based on the PGA setting.)

At PGA = /8, full-scale range =  $\pm 320$  mV (decimal = 32000). For V<sub>SHUNT</sub> =  $\pm 320$  mV, Value = 7D00h; For V<sub>SHUNT</sub> = -320 mV, Value = 8300h; and LSB =  $10 \mu$ V.

#### Figure 20. Shunt Voltage Register at PGA = /8

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
SIGN	SD14_ 8	SD13_ 8	SD12_ 8	SD11_ 8	SD10_ 8	SD9_8	SD8_8	SD7_8	SD6_8	SD5_8	SD4_8	SD3_8	SD2_8	SD1_8	SD0_8

At PGA = /4, full-scale range = ±160 mV (decimal = 16000). For V<sub>SHUNT</sub> = +160 mV, Value = 3E80h; For V<sub>SHUNT</sub> = -160 mV, Value = C180h; and LSB = 10  $\mu$ V.



#### Figure 21. Shunt Voltage Register at PGA = /4

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
SIGN	SIGN	SD13_ 4	SD12_ 4	SD11_ 4	SD10_ 4	SD9_4	SD8_4	SD7_4	SD6_4	SD5_4	SD4_4	SD3_4	SD2_4	SD1_4	SD0_4

At PGA = /2, full-scale range =  $\pm 80 \text{ mV}$  (decimal = 8000). For V<sub>SHUNT</sub> =  $\pm 80 \text{ mV}$ , Value = 1F40h; For V<sub>SHUNT</sub> = -80 mV, Value = E0C0h; and LSB =  $10 \mu$ V.

#### Figure 22. Shunt Voltage Register at PGA = /2

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
SIGN	SIGN	SIGN	SD12_ 2	SD11_ 2	SD10_ 2	SD9_2	SD8_2	SD7_2	SD6_2	SD5_2	SD4_2	SD3_2	SD2_2	SD1_2	SD0_2

At PGA = /1, full-scale range =  $\pm 40 \text{ mV}$  (decimal = 4000). For V<sub>SHUNT</sub> =  $\pm 40 \text{ mV}$ , Value = 0FA0h; For V<sub>SHUNT</sub> = -40 mV, Value = F060h; and LSB =  $10 \mu$ V.

#### Figure 23. Shunt Voltage Register at PGA = /1

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
SIGN	SIGN	SIGN	SIGN	SD11_ 1	SD10_ 1	SD9_1	SD8_1	SD7_1	SD6_1	SD5_1	SD4_1	SD3_1	SD2_1	SD1_1	SD0_1

INA220 ZHCSFN7E – JUNE 2009 – REVISED JANUARY 2016

www.ti.com.cn

# Table 6. Shunt Voltage Register Format<sup>(1)</sup>

V <sub>SHUNT</sub> Reading (mV)	Decimal Value	PGA = /8 (D15:D0)	PGA = /4 (D15:D0)	PGA = /2 (D15:D0)	PGA = /1 (D15:D0)
320.02	32002	0111 1101 0000 0000	0011 1110 1000 0000	0001 1111 0100 0000	0000 1111 1010 0000
320.01	32001	0111 1101 0000 0000	0011 1110 1000 0000	0001 1111 0100 0000	0000 1111 1010 0000
320.00	32000	0111 1101 0000 0000	0011 1110 1000 0000	0001 1111 0100 0000	0000 1111 1010 0000
319.99	31999	0111 1100 1111 1111	0011 1110 1000 0000	0001 1111 0100 0000	0000 1111 1010 0000
319.98	31998	0111 1100 1111 1110	0011 1110 1000 0000	0001 1111 0100 0000	0000 1111 1010 0000
:	:	:	i	:	:
160.02	16002	0011 1110 1000 0010	0011 1110 1000 0000	0001 1111 0100 0000	0000 1111 1010 0000
160.01	16001	0011 1110 1000 0001	0011 1110 1000 0000	0001 1111 0100 0000	0000 1111 1010 0000
160.00	16000	0011 1110 1000 0000	0011 1110 1000 0000	0001 1111 0100 0000	0000 1111 1010 0000
159.99	15999	0011 1110 0111 1111	0011 1110 0111 1111	0001 1111 0100 0000	0000 1111 1010 0000
159.98	15998	0011 1110 0111 1110	0011 1110 0111 1110	0001 1111 0100 0000	0000 1111 1010 0000
:	:	:	I	:	:
80.02	8002	0001 1111 0100 0010	0001 1111 0100 0010	0001 1111 0100 0000	0000 1111 1010 0000
80.01	8001	0001 1111 0100 0001	0001 1111 0100 0001	0001 1111 0100 0000	0000 1111 1010 0000
80.00	8000	0001 1111 0100 0000	0001 1111 0100 0000	0001 1111 0100 0000	0000 1111 1010 0000
79.99	7999	0001 1111 0011 1111	0001 1111 0011 1111	0001 1111 0011 1111	0000 1111 1010 0000
79.98	7998	0001 1111 0011 1110	0001 1111 0011 1110	0001 1111 0011 1110	0000 1111 1010 0000
:	:	:	1	:	:
40.02	4002	0000 1111 1010 0010	0000 1111 1010 0010	0000 1111 1010 0010	0000 1111 1010 0000
40.01	4001	0000 1111 1010 0001	0000 1111 1010 0001	0000 1111 1010 0001	0000 1111 1010 0000
40.00	4000	0000 1111 1010 0000	0000 1111 1010 0000	0000 1111 1010 0000	0000 1111 1010 0000
39.99	3999	0000 1111 1001 1111	0000 1111 1001 1111	0000 1111 1001 1111	0000 1111 1001 1111
39.98	3998	0000 1111 1001 1110	0000 1111 1001 1110	0000 1111 1001 1110	0000 1111 1001 1110
:	:	1	1	:	:
0.02	2				0000 0000 0000 0010
0.02	1	0000 0000 0000 0010	0000 0000 0000 0001	0000 0000 0000 0001	0000 0000 0000 0001
0.01	0	0000 0000 0000 0000	0000 0000 0000 0000	0000 0000 0000 0000	0000 0000 0000 0000
0.01	-1				
-0.02	-1	1111 1111 1111 1111	1111 1111 1111 1111	1111 1111 1111 1111	1111 1111 1111 1111
-0.02	-2	1111 1111 1111 1110	1111 1111 1111 1110	1111 1111 1111 1110 E	1111 1111 1111 1110 E
-39.98	-3998	1111 0000 0110 0010	1111 0000 0110 0010	1111 0000 0110 0010	1111 0000 0110 0010
-39.99	-3999	1111 0000 0110 0001	1111 0000 0110 0001	1111 0000 0110 0001	1111 0000 0110 0001
-40.00	-4000	1111 0000 0110 0000	1111 0000 0110 0000	1111 0000 0110 0000	1111 0000 0110 0000
-40.01	-4001	1111 0000 0101 1111	1111 0000 0101 1111	1111 0000 0101 1111	1111 0000 0110 0000
-40.02	-4002	1111 0000 0101 1110	1111 0000 0101 1110	1111 0000 0101 1110	1111 0000 0110 0000
	:	•	1	:	:
-79.98	-7998	1110 0000 1100 0010	1110 0000 1100 0010	1110 0000 1100 0010	1111 0000 0110 0000
-79.99	-7999	1110 0000 1100 0001	1110 0000 1100 0001	1110 0000 1100 0001	1111 0000 0110 0000
-80.00	-8000	1110 0000 1100 0000	1110 0000 1100 0000	1110 0000 1100 0000	1111 0000 0110 0000
-80.01	-8001	1110 0000 1011 1111	1110 0000 1011 1111	1110 0000 1100 0000	1111 0000 0110 0000
-80.02	-8002	1110 0000 1011 1110	1110 0000 1011 1110	1110 0000 1100 0000	1111 0000 0110 0000
1	:	:		:	:
-159.98	-15998	1100 0001 1000 0010	1100 0001 1000 0010	1110 0000 1100 0000	1111 0000 0110 0000
-159.99	-15999	1100 0001 1000 0001	1100 0001 1000 0001	1110 0000 1100 0000	1111 0000 0110 0000
-160.00	-16000	1100 0001 1000 0000	1100 0001 1000 0000	1110 0000 1100 0000	1111 0000 0110 0000
-160.01	-16001	1100 0001 0111 1111	1100 0001 1000 0000	1110 0000 1100 0000	1111 0000 0110 0000
-160.02	-16002	1100 0001 0111 1110	1100 0001 1000 0000	1110 0000 1100 0000	1111 0000 0110 0000
:	:	:	!	:	:
-319.98	-31998	1000 0011 0000 0010	1100 0001 1000 0000	1110 0000 1100 0000	1111 0000 0110 0000
-319.99	-31999	1000 0011 0000 0001	1100 0001 1000 0000	1110 0000 1100 0000	1111 0000 0110 0000
-320.00	-32000	1000 0011 0000 0000	1100 0001 1000 0000	1110 0000 1100 0000	1111 0000 0110 0000
-320.01	-32001	1000 0011 0000 0000	1100 0001 1000 0000	1110 0000 1100 0000	1111 0000 0110 0000
-320.02	-32002	1000 0011 0000 0000	1100 0001 1000 0000	1110 0000 1100 0000	1111 0000 0110 0000

(1) Out-of-range values are shown in gray shading.



#### 8.6.3.2 Bus Voltage Register (address = 02h)

The Bus Voltage register stores the most recent bus voltage reading, V<sub>BUS</sub>.

At full-scale range = 32 V (decimal = 8000, hex = 1F40), and LSB = 4 mV.

#### Figure 24. Bus Voltage Register (BRNG = 1)

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
BD12	BD11	BD10	BD9	BD8	BD7	BD6	BD5	BD4	BD3	BD2	BD1	BD0		CNVR	OVF

At full-scale range = 16 V (decimal = 4000, hex = 0FA0), and LSB = 4 mV.

Figure 25. Bus Voltage Register (BRNG
---------------------------------------

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	BD11	BD10	BD9	BD8	BD7	BD6	BD5	BD4	BD3	BD2	BD1	BD0	_	CNVR	OVF

#### CNVR: Conversion Ready

 Bit 1
 Although the data from the last conversion can be read at any time, the INA220 Conversion Ready bit (CNVR) indicates when data from a conversion is available in the data output registers. The CNVR bit is set after all conversions, averaging, and multiplications are complete. CNVR will clear under the following conditions:

 1.) Writing a new mode into the Operating Mode bits in the Configuration Register (except for Power-Down or Disable)

 2.) Reading the Power Register

#### OVF: Math Overflow Flag

Bit 0

The Math Overflow Flag (OVF) is set when the Power or Current calculations are out of range. It indicates that current and power data may be meaningless.

#### 8.6.3.3 Power Register (address = 03h) [reset = 00h]

Full-scale range and LSB are set by the Calibration register. See Programming the INA220 Calibration Register.

#### Figure 26. Power Register

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
PD15	PD14	PD13	PD12	PD11	PD10	PD9	PD8	PD7	PD6	PD5	PD4	PD3	PD2	PD1	PD0
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

The Power register records power in watts by multiplying the values of the current with the value of the bus voltage according to the Equation 5:

#### 8.6.3.4 Current Register (address = 04h) [reset =00h]

Full-scale range and LSB depend on the value entered in the Calibration register. See *Programming the INA220 Calibration Register*. Negative values are stored in 2's complement format.

#### Figure 27. Current Register

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
CSIGN	CD14	CD13	CD12	CD11	CD10	CD9	CD8	CD7	CD6	CD5	CD4	CD3	CD2	CD1	CD0
R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0	R-0

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset



The value of the Current register is calculated by multiplying the value in the Shunt Voltage register with the value in the Calibration register according to the Equation 4.

#### 8.6.4 Calibration Register

#### 8.6.4.1 Calibration Register (address = 05h) [reset = 00h]

Current and power calibration are set by bits FS15 to FS1 of the Calibration register. Note that bit FS0 is not used in the calculation. This register sets the current that corresponds to a full-scale drop across the shunt. Full-scale range and the LSB of the current and power measurement depend on the value entered in this register. See the *Programming the INA220 Calibration Register*. This register is suitable for use in overall system calibration. Note that the 0 POR values are all default.

Figure 28.	Calibration Register <sup>(1)</sup>
------------	-------------------------------------

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
FS15	FS14	FS13	FS12	FS11	FS10	FS9	FS8	FS7	FS6	FS5	FS4	FS3	FS2	FS1	FS0
R/W-0	R-0														

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

(1) FS0 is a void bit and will always be 0. It is not possible to write a 1 to FS0. CALIBRATION is the value stored in FS15:FS1.



### 9 Application and Implementation

#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

#### 9.1 Application Information

The INA220 is a digital current-shunt monitor with an I<sup>2</sup>C- and SMBus-compatible interface. It provides digital current, voltage, and power readings necessary for accurate decision-making in precisely-controlled systems. Programmable registers allow flexible configuration for measurement resolution, and continuous-versus-triggered operation. See Table 2 for detailed register information. See Figure 29 for a block diagram of the INA220.

### 9.2 Typical Application

Figure 29 shows a typical application circuit for the INA220. Use a 0.1-µF ceramic capacitor for power-supply bypassing, placed as closely as possible to the supply and ground pins.

The input filter circuit consisting of  $R_{F1}$ ,  $R_{F2}$ , and  $C_F$  is not necessary in most applications. If the need for filtering is unknown, reserve board space for the components and install 0- $\Omega$  resistors unless a filter is needed. See *Filtering and Input Considerations*.



Figure 29. General Load, Low- or High-Side Sensing

#### 9.2.1 Design Requirements

The INA220 measures the voltage across a current-sensing resistor ( $R_{SHUNT}$ ) when current passes through the resistor. The device also measures the bus supply voltage, and calculates power when calibrated. This section goes through the steps to program the device for power measurements, and shows the register results in Table 7. The Conditions for the example circuit is: Maximum expected load current = 15 A, Nominal load current = 10 A, VCM = 12 V,  $R_{SHUNT} = 2 m\Omega$ ,  $V_{SHUNT} FSR = 40 \text{ mV}$  (PGA = /1), and BRNG = 0 (VBUS range = 16 V).

#### 9.2.2 Detailed Design Procedure

In this example, the 10-A load creates a differential voltage of 20 mV across a 2-m $\Omega$  shunt resistor. The voltage present at the IN– pin is equal to the common-mode voltage minus the differential drop across the resistor. The bus voltage for the INA220 is measured at the external VBUS input pin, which in this example is connected to the IN– pin to measure the voltage level delivered to the load. For this example, the voltage at the IN– pin is 11.98 V. For this particular range (40-mV full-scale), this small difference is not a significant deviation from the 12-V common-mode voltage. However, at larger full-scale ranges, this deviation can be much larger.



#### **Typical Application (continued)**

Note that the Bus Voltage register bits are not right-aligned. To compute the value of the Bus Voltage register contents using the LSB of 4 mV, the register must be shifted right by three bits. This shift puts the BD0 bit in the LSB position so that the contents can be multiplied by the 4-mV LSB value to compute the bus voltage measured by the device. The shifted value of the bus voltage register contents is now equal to BB3h, a decimal equivalent of 2995. This value of 2995 multiplied by the 4-mV LSB results in a value of 11.98 V.

The Calibration register (05h) is set to provide the device information about the current shunt resistor that was used to create the measured shunt voltage. By knowing the value of the shunt resistor, the device can then calculate the amount of current that created the measured shunt voltage drop. The first step when calculating the calibration value is setting the current LSB. The Calibration register value is based on a calculation that has its precision capability limited by the size of the register and the Current register LSB. The device can measure bidirectional current; thus, the MSB of the Current register is a sign bit that allows for the rest of the 15 bits to be used for the Current register value. For this example, the minimum current LSB would be 457.78 µA/bit assuming a maximum expected current of 15 A using Equation 2. For this example, a value of 1 mA/bit was chosen for the current LSB. Setting the current LSB to this value allows for sufficient precision while serving to simplify the math as well. Using Equation 1 results in a Calibration register value of 20480 or 5000h.

The Current register (04h) is internally calculated by multiplying the shunt voltage contents by the Calibration register and then dividing by 4096 using Equation 4. For this example, the shunt voltage of 2000 is multiplied by the Calibration register of 20480 and then divided by 4096 to yield a Current register value of 10000 (2710h).

The Power register (03h) is internally calculated by multiplying the Current register value of 10000 by the Bus Voltage register value of 2995 and then dividing by 5000 using Equation 5. For this example, the Power register contents are 5990 (1766h). Multiplying this result by the power LSB that is 20 times the  $1 \times 10^{-3}$  current LSB, or  $20 \times 10^{-3}$ , results in a power calculation of 5990 × 20 mW/bit, which equals 119.8 W. This result matches what is expected for this register. A manual calculation for the power being delivered to the load would use 11.98 V (12 VCM – 20 mV shunt drop) multiplied by the load current of 10 A to give a 119.8-W result.



Figure 30. Example Circuit Configuration



#### **Typical Application (continued)**

#### 9.2.2.1 Register Results for the Example Circuit

Table 7 shows the register readings for the Calibration example.

		rable in Register i	toounto			
REGISTER NAME	ADDRESS	CONTENTS	ADJ	DEC	LSB	VALUE
Configuration	00h	019Fh				
Shunt	01h	07D0h		2000	10 µV	20 mV
Bus	02h	5D98h	0BB3	2995	4 mV	11.98 V
Calibration	05h	5000h		20480		
Current	04h	2710h		10000	1 mA	10.0 A
Power	03h	1766h		5990	20 mW	119.8 W

#### Table 7. Register Results<sup>(1)</sup>

(1) Conditions: load = 10 A,  $V_{CM}$  = 12 V,  $R_{SHUNT}$  = 2 m $\Omega$ ,  $V_{SHUNT}$  FSR = 40 mV, and  $V_{BUS}$  = 16 V.

#### 9.2.3 Typical Application: –48-V Telecom Current/Voltage/Power Sense With Isolation

Figure 31, Figure 32, and Figure 33 show the INA220 in additional circuit configurations for current, voltage, and power monitoring applications.



Figure 31. -48-V Telecom Current/Voltage/Power Sense With Isolation

#### 9.2.4 Typical Application: 48-V Telecom Current/Voltage/Power Sense



Figure 32. 48-V Telecom Current/Voltage/Power Sense

### 9.2.5 Typical Application: General Source Low-Side Sensing



Figure 33. General Source Low-Side Sensing



### **10** Power Supply Recommendations

The input circuitry of the device can accurately measure signals on common-mode voltages beyond its power supply voltage, V<sub>S</sub>. For example, the voltage applied to the V<sub>S</sub> power supply terminal can be 5 V, whereas the load power-supply voltage being monitored (the common-mode voltage) can be as high as 26 V. Note also that the device can withstand the full 0-V to 26-V range at the input terminals, regardless of whether the device has power applied or not. Place the required power-supply bypass capacitors as close as possible to the supply and ground terminals of the device to ensure stability. A typical value for this supply bypass capacitor is 0.1  $\mu$ F. Applications with noisy or high-impedance power supplies may require additional decoupling capacitors to reject power-supply noise.

### 11 Layout

#### 11.1 Layout Guidelines

Connect the input pins (IN+ and IN–) to the sensing resistor using a Kelvin connection or a 4-wire connection. These connection techniques ensure that only the current-sensing resistor impedance is detected between the input pins. Poor routing of the current-sensing resistor commonly results in additional resistance present between the input pins. Given the very low ohmic value of the current-sensing resistor, any additional high-current carrying impedance causes significant measurement errors. Place the power-supply bypass capacitor as close as possible to the supply and ground pins.

#### 11.2 Layout Example



Figure 34. Layout Recommendation

# 12 器件和文档支持

### 12.1 相关文档

相关文档,请参见《TPS2490/1 正电压较高的功率限制热插拔控制器》数据表(文献编号:SLVS503)。

#### 12.2 社区资源

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E<sup>™</sup> Online Community *TI's Engineer-to-Engineer (E2E) Community.* Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support TI's Design Support** Quickly find helpful E2E forums along with design support tools and contact information for technical support.

#### 12.3 商标

E2E is a trademark of Texas Instruments. All other trademarks are the property of their respective owners.

#### **12.4** 静电放电警告



这些装置包含有限的内置 ESD 保护。存储或装卸时,应将导线一起截短或将装置放置于导电泡棉中,以防止 MOS 门极遭受静电损伤。

### 12.5 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

### 13 机械、封装和可订购信息

以下页中包括机械、封装和可订购信息。这些信息是针对指定器件可提供的最新数据。这些数据会在无通知且不对 本文档进行修订的情况下发生改变。欲获得该数据表的浏览器版本,请查阅左侧的导航栏

#### 重要声明

德州仪器 (TI) 公司有权按照最新发布的 JESD46 对其半导体产品和服务进行纠正、增强、改进和其他修改,并不再按最新发布的 JESD48 提供任何产品和服务。买方在下订单前应获取最新的相关信息,并验证这些信息是否完整且是最新的。

TI 公布的半导体产品销售条款 (http://www.ti.com/sc/docs/stdterms.htm) 适用于 TI 已认证和批准上市的已封装集成电路产品的销售。另有其他条款可能适用于其他类型 TI 产品及服务的使用或销售。

复制 TI 数据表上 TI 信息的重要部分时,不得变更该等信息,且必须随附所有相关保证、条件、限制和通知,否则不得复制。TI 对该等复制文件不承担任何责任。第三方信息可能受到其它限制条件的制约。在转售 TI 产品或服务时,如果存在对产品或服务参数的虚假陈述,则会失去相关 TI 产品或服务的明示或暗示保证,且构成不公平的、欺诈性商业行为。TI 对此类虚假陈述不承担任何责任。

买方和在系统中整合 TI 产品的其他开发人员(总称"设计人员")理解并同意,设计人员在设计应用时应自行实施独立的分析、评价和判断,且 应全权 负责并确保 应用的安全性,及设计人员的 应用 (包括应用中使用的所有 TI 产品)应符合所有适用的法律法规及其他相关要求。设计 人员就自己设计的 应用声明,其具备制订和实施下列保障措施所需的一切必要专业知识,能够 (1)预见故障的危险后果,(2)监视故障及其后 果,以及 (3)降低可能导致危险的故障几率并采取适当措施。设计人员同意,在使用或分发包含 TI 产品的任何 应用前,将彻底测试该等 应用 和 该等应用中所用 TI 产品的 功能。

TI 提供技术、应用或其他设计建议、质量特点、可靠性数据或其他服务或信息,包括但不限于与评估模块有关的参考设计和材料(总称"TI资源"),旨在帮助设计人员开发整合了 TI 产品的 应用,如果设计人员(个人,或如果是代表公司,则为设计人员的公司)以任何方式下载、访问或使用任何特定的 TI 资源,即表示其同意仅为该等目标,按照本通知的条款使用任何特定 TI 资源。

TI 所提供的 TI 资源,并未扩大或以其他方式修改 TI 对 TI 产品的公开适用的质保及质保免责声明;也未导致 TI 承担任何额外的义务或责任。 TI 有权对其 TI 资源进行纠正、增强、改进和其他修改。除特定 TI 资源的公开文档中明确列出的测试外,TI 未进行任何其他测试。

设计人员只有在开发包含该等 TI 资源所列 TI 产品的 应用时,才被授权使用、复制和修改任何相关单项 TI 资源。但并未依据禁止反言原则或 其他法理授予您任何TI知识产权的任何其他明示或默示的许可,也未授予您 TI 或第三方的任何技术或知识产权的许可,该等产权包括但不限 于任何专利权、版权、屏蔽作品权或与使用TI产品或服务的任何整合、机器制作、流程相关的其他知识产权。涉及或参考了第三方产品或服务 的信息不构成使用此类产品或服务的许可或与其相关的保证或认可。使用 TI 资源可能需要您向第三方获得对该等第三方专利或其他知识产权 的许可。

TI 资源系"按原样"提供。TI 兹免除对资源及其使用作出所有其他明确或默认的保证或陈述,包括但不限于对准确性或完整性、产权保证、无屡 发故障保证,以及适销性、适合特定用途和不侵犯任何第三方知识产权的任何默认保证。TI 不负责任何申索,包括但不限于因组合产品所致或 与之有关的申索,也不为或对设计人员进行辩护或赔偿,即使该等产品组合已列于 TI 资源或其他地方。对因 TI 资源或其使用引起或与之有关 的任何实际的、直接的、特殊的、附带的、间接的、惩罚性的、偶发的、从属或惩戒性损害赔偿,不管 TI 是否获悉可能会产生上述损害赔 偿,TI 概不负责。

除 TI 己明确指出特定产品已达到特定行业标准(例如 ISO/TS 16949 和 ISO 26262)的要求外,TI 不对未达到任何该等行业标准要求而承担任何责任。

如果 TI 明确宣称产品有助于功能安全或符合行业功能安全标准,则该等产品旨在帮助客户设计和创作自己的 符合 相关功能安全标准和要求的 应用。在应用内使用产品的行为本身不会 配有 任何安全特性。设计人员必须确保遵守适用于其应用的相关安全要求和 标准。设计人员不可将 任何 TI 产品用于关乎性命的医疗设备,除非己由各方获得授权的管理人员签署专门的合同对此类应用专门作出规定。关乎性命的医疗设备是 指出现故障会导致严重身体伤害或死亡的医疗设备(例如生命保障设备、心脏起搏器、心脏除颤器、人工心脏泵、神经刺激器以及植入设备)。此类设备包括但不限于,美国食品药品监督管理局认定为 III 类设备的设备,以及在美国以外的其他国家或地区认定为同等类别设备的 所有医疗设备。

TI 可能明确指定某些产品具备某些特定资格(例如 Q100、军用级或增强型产品)。设计人员同意,其具备一切必要专业知识,可以为自己的应用选择适合的产品,并且正确选择产品的风险由设计人员承担。设计人员单方面负责遵守与该等选择有关的所有法律或监管要求。 设计人员同意向 TI 及其代表全额赔偿因其不遵守本通知条款和条件而引起的任何损害、费用、损失和/或责任。

> 邮寄地址:上海市浦东新区世纪大道 1568 号中建大厦 32 楼,邮政编码: 200122 Copyright © 2017 德州仪器半导体技术(上海)有限公司



10-Nov-2016

# PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
INA220AIDGSR	ACTIVE	VSSOP	DGS	10	2500	Green (RoHS & no Sb/Br)	CU NIPDAU   CU NIPDAUAG	Level-2-260C-1 YEAR	-40 to 125	OOUI	Samples
INA220AIDGST	ACTIVE	VSSOP	DGS	10	250	Green (RoHS & no Sb/Br)	CU NIPDAU   CU NIPDAUAG	Level-2-260C-1 YEAR	-40 to 125	OOUI	Samples
INA220BIDGSR	ACTIVE	VSSOP	DGS	10	2500	Green (RoHS & no Sb/Br)	CU NIPDAU   CU NIPDAUAG	Level-2-260C-1 YEAR	-40 to 125	ZAEI	Samples
INA220BIDGST	ACTIVE	VSSOP	DGS	10	250	Green (RoHS & no Sb/Br)	CU NIPDAU   CU NIPDAUAG	Level-2-260C-1 YEAR	-40 to 125	ZAEI	Samples

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.



www.ti.com

10-Nov-2016

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

# PACKAGE MATERIALS INFORMATION

www.ti.com

Texas Instruments

# TAPE AND REEL INFORMATION





# QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
INA220AIDGSR	VSSOP	DGS	10	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
INA220AIDGSR	VSSOP	DGS	10	2500	330.0	12.4	5.3	3.3	1.3	8.0	12.0	Q1
INA220AIDGST	VSSOP	DGS	10	250	180.0	12.4	5.3	3.3	1.3	8.0	12.0	Q1
INA220AIDGST	VSSOP	DGS	10	250	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
INA220BIDGSR	VSSOP	DGS	10	2500	330.0	12.4	5.3	3.3	1.3	8.0	12.0	Q1
INA220BIDGSR	VSSOP	DGS	10	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
INA220BIDGST	VSSOP	DGS	10	250	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
INA220BIDGST	VSSOP	DGS	10	250	180.0	12.4	5.3	3.3	1.3	8.0	12.0	Q1

Texas Instruments

www.ti.com

# PACKAGE MATERIALS INFORMATION

16-May-2019



*All dimensions are nominal							
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
INA220AIDGSR	VSSOP	DGS	10	2500	366.0	364.0	50.0
INA220AIDGSR	VSSOP	DGS	10	2500	370.0	355.0	55.0
INA220AIDGST	VSSOP	DGS	10	250	195.0	200.0	45.0
INA220AIDGST	VSSOP	DGS	10	250	366.0	364.0	50.0
INA220BIDGSR	VSSOP	DGS	10	2500	370.0	355.0	55.0
INA220BIDGSR	VSSOP	DGS	10	2500	366.0	364.0	50.0
INA220BIDGST	VSSOP	DGS	10	250	366.0	364.0	50.0
INA220BIDGST	VSSOP	DGS	10	250	195.0	200.0	45.0

# **DGS0010A**



# **PACKAGE OUTLINE**

# VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M. 2. This drawing is subject to change without notice. 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not
- exceed 0.15 mm per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm per side.
- 5. Reference JEDEC registration MO-187, variation BA.



# DGS0010A

# **EXAMPLE BOARD LAYOUT**

# VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



# DGS0010A

# **EXAMPLE STENCIL DESIGN**

# VSSOP - 1.1 mm max height

SMALL OUTLINE PACKAGE



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



#### 重要声明和免责声明

Ⅱ 均以"原样"提供技术性及可靠性数据(包括数据表)、设计资源(包括参考设计)、应用或其他设计建议、网络工具、安全信息和其他资源,不保证其中不含任何瑕疵,且不做任何明示或暗示的担保,包括但不限于对适销性、适合某特定用途或不侵犯任何第三方知识产权的暗示担保。

所述资源可供专业开发人员应用TI产品进行设计使用。您将对以下行为独自承担全部责任:(1)针对您的应用选择合适的TI产品;(2)设计、 验证并测试您的应用;(3)确保您的应用满足相应标准以及任何其他安全、安保或其他要求。所述资源如有变更,恕不另行通知。TI对您使用 所述资源的授权仅限于开发资源所涉及TI产品的相关应用。除此之外不得复制或展示所述资源,也不提供其它TI或任何第三方的知识产权授权 许可。如因使用所述资源而产生任何索赔、赔偿、成本、损失及债务等,TI对此概不负责,并且您须赔偿由此对TI及其代表造成的损害。

TI所提供产品均受TI的销售条款 (http://www.ti.com.cn/zh-cn/legal/termsofsale.html) 以及ti.com.cn上或随附TI产品提供的其他可适用条款的约束。TI提供所述资源并不扩展或以其他方式更改TI 针对TI 产品所发布的可适用的担保范围或担保免责声明。

邮寄地址:上海市浦东新区世纪大道 1568 号中建大厦 32 楼,邮政编码: 200122 Copyright © 2019 德州仪器半导体技术(上海)有限公司